

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KAZUYOSHI TAKANO	09/19/2023
PAUL NEWBURY	09/14/2023
RECEIVING PARTY DATA	
Name:	SENKO ADVANCED COMPONENTS, INC.
Street Address:	2 CABOT ROAD, SUITE 103
City:	HUDSON
State/Country:	MASSACHUSETTS
Postal Code:	01749
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	11275221
CORRESPONDENCE DATA	
Fax Number:	(314)863-9388
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	3148630800
Email:	stl.uspatents@stinson.com
Correspondent Name:	STINSON LLP
Address Line 1:	7700 FORSYTH BLVD., SUITE 1100
Address Line 4:	ST. LOUIS, MISSOURI 63105
ATTORNEY DOCKET NUMBER:	SENKO10350.US/SP10315US01
NAME OF SUBMITTER:	KIM SCHIMWEG
SIGNATURE:	/Kim Schimweg/
DATE SIGNED:	09/19/2023
Total Attachments: 5	
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ASSIGNMENT

WHEREAS, We, Kazuyoshi Takano of Tokyo, Japan, and Paul Newbury of Ashland, Massachusetts, have invented an improvement in Springless Retention Structure for an Ingress Protected Hybrid Connector Assembly (SP10315US01; SENKO10350.US) and have executed an application for a United States patent based thereon assigned Serial No. 16/654,767, filed October 16, 2019, issued as U.S. Patent No. 11,275,221 on March 15, 2022;

AND, WHEREAS, Senko Advanced Components, Inc. of Hudson, Massachusetts, a corporation of the State of Massachusetts (hereinafter referred to as "ASSIGNEE") is desirous of acquiring certain rights thereunder;

NOW, THEREFORE, for one dollar and other good and valuable consideration, receipt of all of which is hereby acknowledged, we have agreed to and do hereby sell, assign and transfer unto said ASSIGNEE the entire right, title and interest, including the right to claim priority, in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto in and to said invention, said United States application, any other United States applications (including provisional, non-provisional, divisional, continuing, or reissue applications) based in whole or in part on said United States application or in whole or in part on said invention, any foreign applications based in whole or in part on any of the aforesaid United States applications or in whole or

in part on said invention, and any and all patents (including extensions thereof) of any country which have been or may be granted on any of the aforesaid applications or on said invention or any part thereof;

TO BE HELD AND ENJOYED by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by us had no sale and assignment of said interest been made;

AND We hereby authorize and request the Director of the United States Patent and Trademark Office of the United States of America to issue any and all United States patents which may be granted upon said United States applications or any of them, or upon said invention or any part thereof, to said ASSIGNEE;

AND We hereby jointly and severally agree for ourselves and for our respective heirs, executors and administrators, to execute without further consideration any further lawful documents and any further assurances, and any provisional, non-provisional, divisional, continuing, reissue, or other applications for patents of any country, that may be deemed necessary by said ASSIGNEE fully to secure to said ASSIGNEE its interest as aforesaid in and to said invention or any part thereof, and in and to said several patents or any of them;

AND We hereby jointly and severally covenant for ourselves and our respective legal representatives that we have granted no right or license to make, use or sell said invention, to anyone

except said ASSIGNEE, that prior to the execution of this deed our right, title and interest in said invention had not been otherwise encumbered, and that we have not executed and will not execute any instrument in conflict herewith.

IN WITNESS WHEREOF, we have hereunto set our hands.

Sep 19, 2023
Date

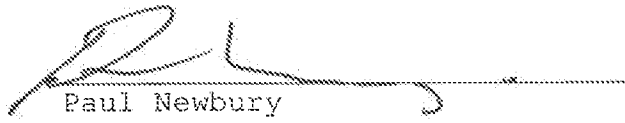

Kazuyoshi Takano

Sep 19, 2023
Date


Kenji
Signature of Witness

Kenji Iizumi
Printed Name of Witness

7/14/2023
Date


Paul Newbury

9/14/23
Date


Signature of Witness

Yoko Tanaka
Printed Name of Witness

KFJ/krs